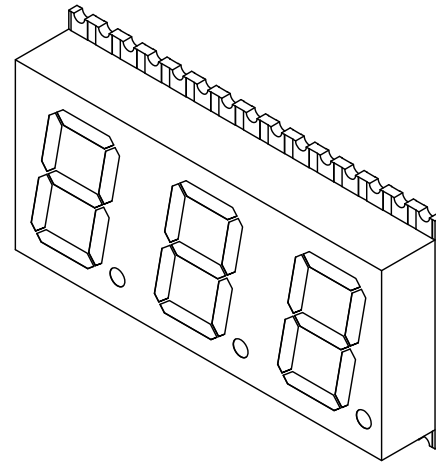
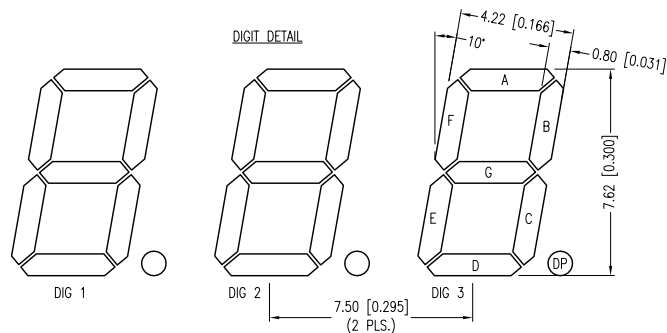
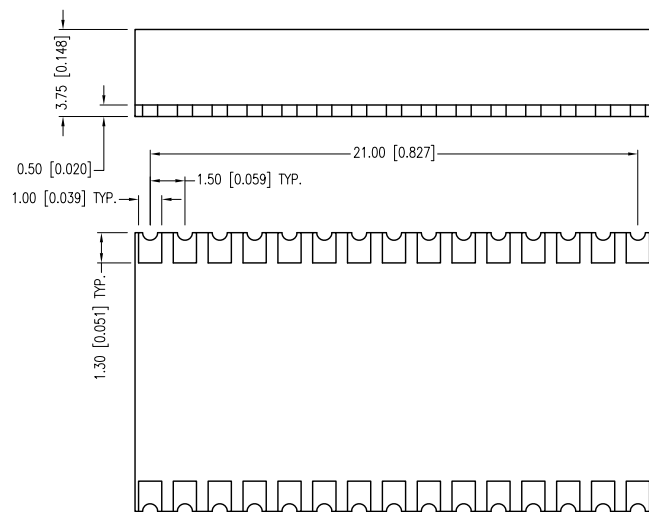
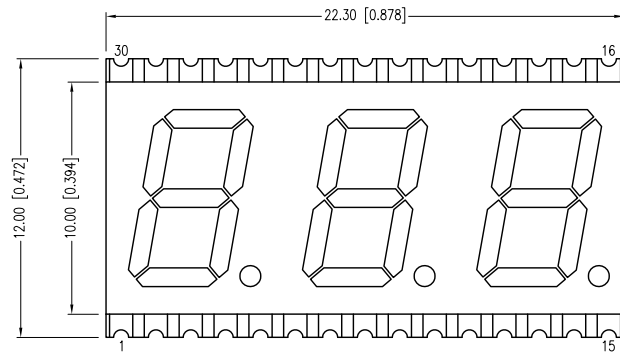


PART NUMBER	LDT-SMC3002RIUPGTR	REV.	A
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ELECTRO-OPTICAL CHARACTERISTICS $T_a=25^\circ\text{C}$ $I_f=10\text{mA}$

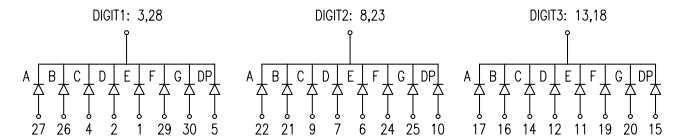
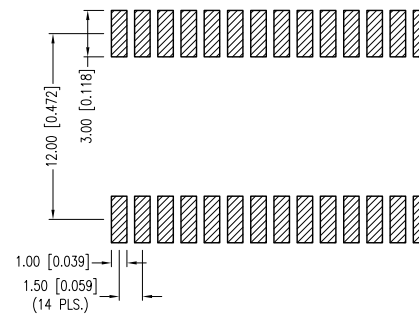
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		525		nm	
FORWARD VOLTAGE		3.5	4.0	V _f	
REVERSE VOLTAGE	5.0			V _r	I _r =100 μ A
AXIAL INTENSITY		7000		μcd	I _f =10mA
EMITTED COLOR:	GREEN				
FACE COLOR:	GRAY				
SEGMENT COLOR:	MILKY WHITE DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C PER CHIP

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	25	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING TEMP.	-40 TO +85	°C
STORAGE TEMP.	-40 TO +85	°C

* $t < 10\mu\text{s}$

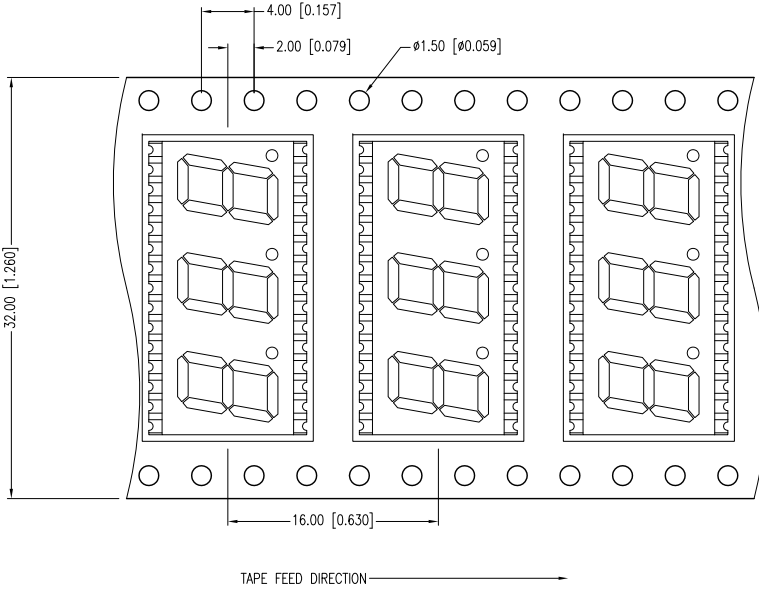
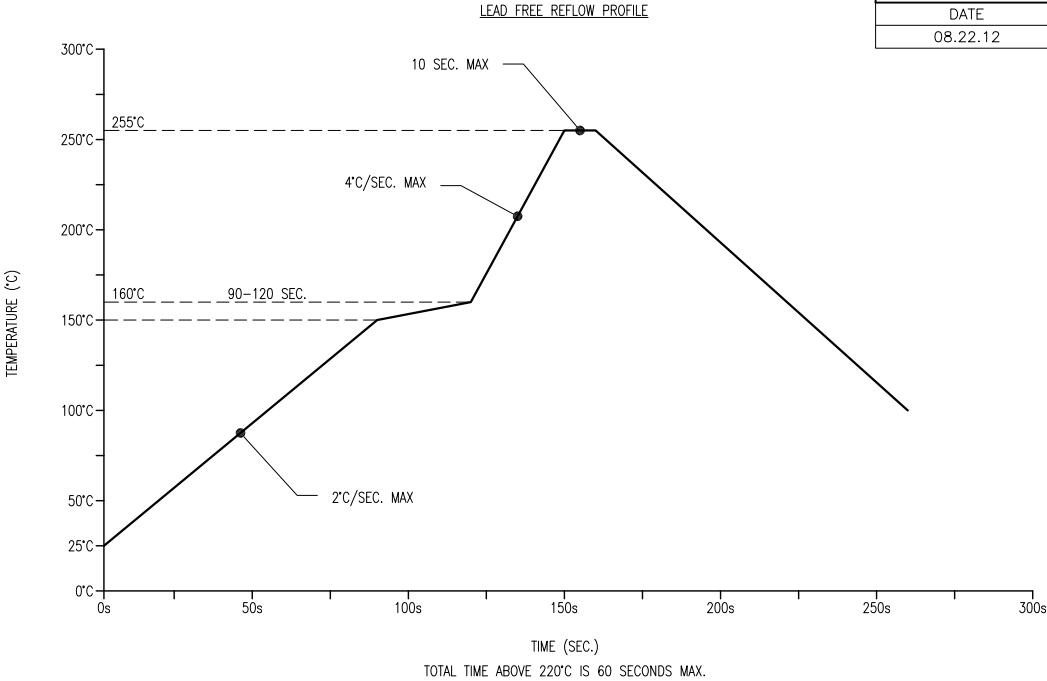
RECOMMENDED SOLDER PAD LAYOUT



*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: $X=\pm 1$ (± 0.039), $X.X=\pm 0.5$ (± 0.020), $X.XX=\pm 0.25$ (± 0.010), $X.XXX=\pm 0.127$ (± 0.005). LEAD SIZE= ± 0.05 (± 0.002), LEAD LENGTH= ± 0.75 (± 0.030). MIN.= $^{+0.00}_{-0.00}$ DECIMAL PRECISION MAX.= $^{+0.00}_{-0.00}$ DECIMAL PRECISION

UNCONTROLLED DOCUMENT

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NOTES:

1. 800 PCS PER REEL.